

# **Final Product Change Notification**

Issue Date:30-Jun-2016Effective Date:14-Oct-2016

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



#### **Management Summary**

Expansion of second source various types in already released TSSOP packages and production sites Change Category

Change Category					
	[]Wafer Fab	[X] Assembly	[X] Product Marking	[X] Test	[] Design
	Process	Process		Location	
	[]Wafer Fab	[X] Assembly	[] Mechanical Specification	[]Test Process	[] Errata
	Materials	Materials			
	[]Wafer Fab	[X] Assembly	[]	[] Test	[] Electrical spec./Test
	Location	Location	Packing/Shipping/Labeling	Equipment	coverage
		· ·	· · ·		

Expansion of second source various types in TSSOP packages

## **Details of this Change**

Expansion of second source various types in already released TSSOP packages and production sites

- Introduce assembly and final test in ATBK (NXP Semiconductors Assembly & Test Plant Bangkok Thailand) for the TSSOP14 package

- Introduce assembly and final test in ASEN (NXP-ASE JV Suzhou, China) for the TSSOP16 package

- All products affected on this notification are currently assembled in ATP (Amkor Technology Manila Philippines)

## Why do we Implement this Change

- Consolidation and optimization of NXP' manufacturing / assembly locations

- Introduction of second source

- To support increased customer demand

- Order Lead-Time Improvement

## **Identification of Affected Products**

Assembly location can be identified by the assembly code that is marked on the product on line "C":

"u" = ATP "n" = ATBK "X"= ASEN

In addition assembly country name is printed on box and reel label

**Product Availability** 

#### Sample Information

Samples are available upon request

Limited samples are available upon request for high volume types in Logic sample store Nijmegen The Netherlands

Production

Planned first shipment 14-Oct-2016

Impact

no impact to the product's functionality anticipated.

### **Data Sheet Revision**

No impact to existing datasheet

## **Disposition of Old Products**

Not applicable

**Timing and Logistics** 

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 30-Jul-2016.

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: Name Emile Busink Position PCN specialist - QA engineering Logic Products

e-mail address emile.busink@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus. Passion to Win.

# NXP Quality Management Team.

## **About NXP Semiconductors**

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

| Privacy Policy | Terms of Use NXP Semiconductors High Tech Campus, 5656 AG Eindhoven, The Netherlands © 2006-2010 NXP Semiconductors. All rights reserved.